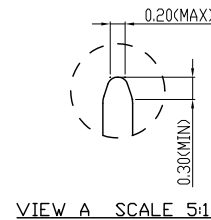
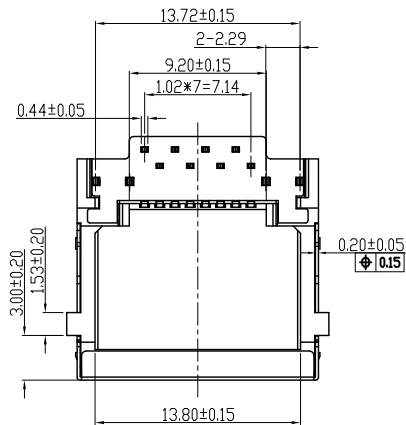
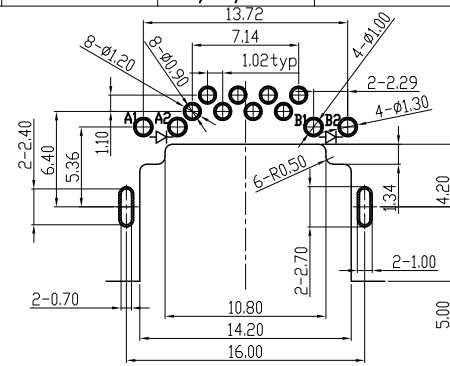


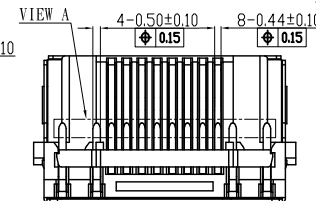
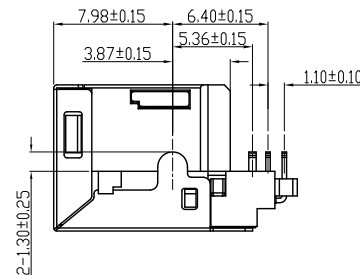
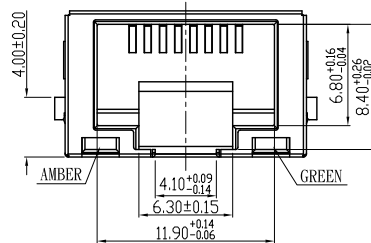
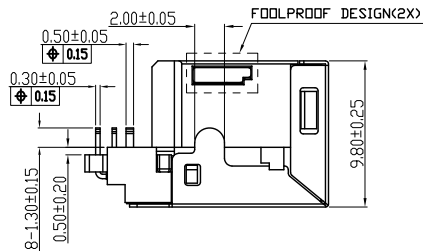
REV	DESCRIPTION	ECN/ECR	DATE	DRAWN BY
A	新訂圖面	—	03/12/2015	胡久量
A	修改字碼位置	ECR	03/12/2019	左胜胜



VIEW A SCALE 5:1



RECOMMENDED PCB LAYOUT
TOLERANCE:±0.05mm
RECOMMENDED PCB THICKNESS:1.20±0.05



NOTES:

1.MATERIAL:

1-1:HOUSING:PA10T+35%GF(VICNYL R635NH);UL 94V-0, COLOR:BLACK

1-2:TERMINAL:PHOSPHOR BRONZE(C5210R-EH);T=0.30mm

TREATMENT:

1.GOLD FLASH ON CONTACT AREA,MATTE SN 50u" MIN

ON SOLDER TAIL,ALL OVER NI 30u" MIN.

2.GOLD 30u" MIN ON CONTACT AREA,MATTE SN 50u" MIN

ON SOLDER TAIL,ALL OVER NI 30u" MIN.

1-3:SHELL:SUS(201);T=0.20mm,TREATMENT:50u" NI

1-4:LED:GREEN/AMBER,TREATMENT:TIN

1-5:STOPPLE:LCP(E6808);UL 94V-0,COLOR:BLACK

1-6:DEFEND :LCP(E6808);UL 94V-0,COLOR:BLACK

1-6:MYLAR:YELLOW

2.SPECIFICATIONS:

2-1.VOLTAGE RATING:150VAC MAX.

2-2.CURRENT RATING:1.5AMP MAX.

2-3.INSULATION RESISTANCE:500MΩ MIN. AT 500V DC.

2-4.DIELECTRIC WITHSTANDING VOLTAGE:

500V AC 60HZ 1MINUTE.

2-5.DURABILITY:5000 CYCLES.

2-6.OPERATING TEMPERATURE:-30°C TO+70°C.

2-7.FOR REFLOW SOLDERING LEAD-FREE PROCESS.

D/C: 15023

星期三
第十周
2015年

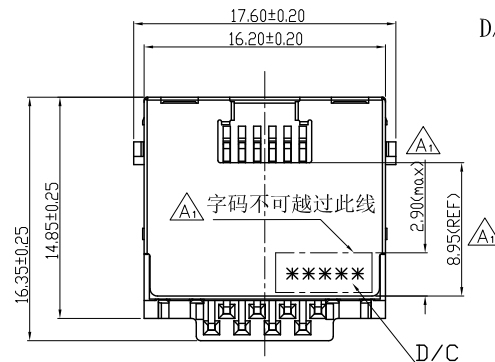
Part Number(凡準)	AU
RJN-010-1L12HG	G/F
RJN-010-1L12H6	30u"

TABLE:

30μ"	CD4521032008	-02	WHITE NI	YES
G/F	CD4521032008	-01	WHITE NI	YES
AU PLATING	PART NUMBER	-XX	SHELL PLATING	HF

LED ELECTRICAL CHARACTERISTIC

NODE	COLOR	———	WAVELENGTE	FORWARD CURREN
A1(+) A2(-)	GREEN	A1  A2	564-577nm	If=20mA
B1(+) B2(-)	AMBER	B1  B2	584-594nm	If=20mA



D/C

東莞世華電子有限公司
SHYH HWA ELECTRONICS CO.,LTD.(DONGGUAN)
地址:東莞市塘廈鎮諸佛嶺178工業區
TEL:0769-87910020-1 FAX:0769-87910210

DRAWN BY 左胜胜
CHECKED BY
APPROVED BY

ITEM MINI RJ45 PHONE JACK(板上4.0mm 二)+柵欄
452專用
PART NO CD4521042010-XX

ANGLE PROJECTION
UNIT mm
SCALE 1:1
DATE 03/12/2019